

Technical Data Sheet

Right Angle Lens Chip LEDs with Bi-Color (Multi-Color)

12-22/BHR6C-A01/2C

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Multi-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.

Descriptions

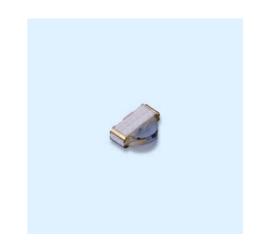
- The 12-22 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

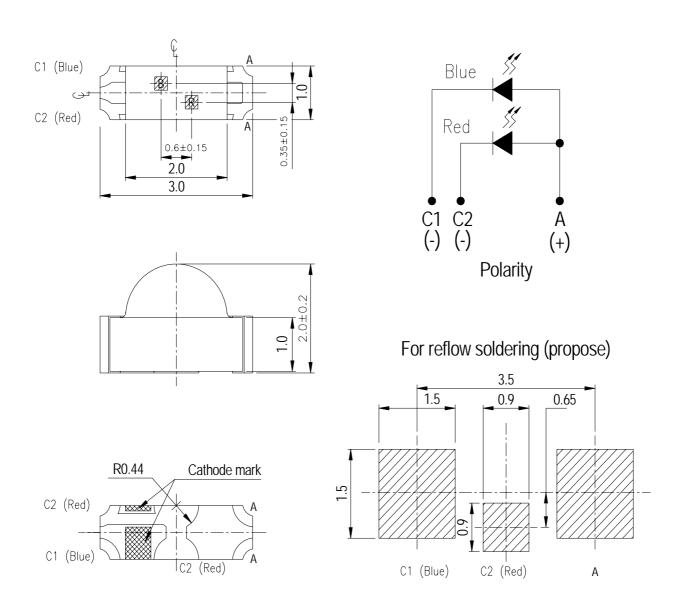
Type	Material Emitted Color		Lens Color	
ВН	InGaN	Blue	W Cl	
R6	AlGaInP	Brilliant Red	Water Clear	



Everlight Electronics Co., Ltd. http://www.everlight.com Rev: 3 Page: 1 of 11

Device No: DSE-122-067 Prepared date: 19-Oct-2005 Prepared by: Jeff Tsai

Package Outline Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

Everlight Electronics Co., Ltd. http://www.everlight.com Rev: 3 Page: 2 of 11

Device No: DSE-122-067 Prepared date: 19-Oct-2005 Prepared by: Jeff Tsai



Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V_R	5	V	
Forward Current	I F	BH:25 R6:25	mA	
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$	
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\!\mathbb{C}$	
Electrostatic Discharge(HBM)	ESD	BH:150 R6:2000	V	
Power Dissipation	Pd	BH:110 R6:60	mW	
Peak Forward Current (Duty 1/10 @1KHz)	IFP	BH:100 R6:60	mA	
Soldering Temperature	Tsol	Reflow Soldering: 260 °C for 10 sec. Hand Soldering: 350 °C for 3 sec.		

Everlight Electronics Co., Ltd. http://www.everlight.com Rev: 3 Page: 3 of 11

Device No: DSE-122-067 Prepared date: 19-Oct-2005 Prepared by: Jeff Tsai



Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol		Min.	Typ.	Max.	Unit	Condition	
* * * * * * * * * * * * * * * * * * * *	Iv	ВН	18.0	28.0		,		
Luminous Intensity		R6	22.5	30.0		mcd		
Viewing Angle	2 0 1/2			120		deg		
D 1 W 1 1	λр	ВН		468		nm	IF=5mA	
Peak Wavelength		R6		632				
Dominant Wavelength	λd	ВН		470		nm		
		R6		624		11111		
Spectrum Radiation	Δλ	ВН		35		nm		
Bandwidth		R6		25		11111		
Forward Voltage	VF	ВН	2.7		3.1	V		
1 of ward voltage		R6	1.7		2.2			
Reverse Current	IR	ВН			50	μ A	V _R =5V	
		R6			10			

Notes:

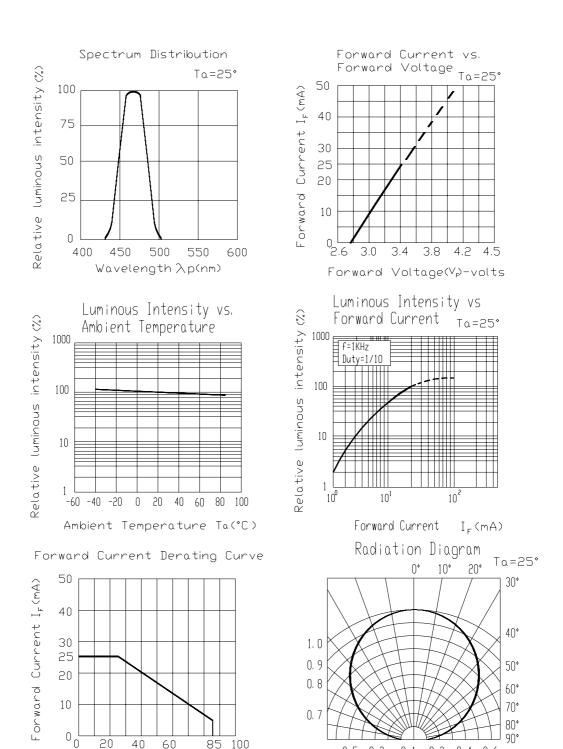
- 1. Tolerance of Luminous Intensity ±10%
- 2. Tolerance of Forward Voltage $\pm 0.05V$

Everlight Electronics Co., Ltd. http://www.everlight.com Rev: 3 Page: 4 of 11

Device No: DSE-122-067 Prepared date: 19-Oct-2005 Prepared by: Jeff Tsai

Typical Electro-Optical Characteristics Curves

BH



Everlight Electronics Co., Ltd. http://www.everlight.com Rev: 3 Page: 5 of 11

Device No: DSE-122-067 Prepared date: 19-Oct-2005 Prepared by: Jeff Tsai

Ambient Temperature Ta(°C)

0. 3

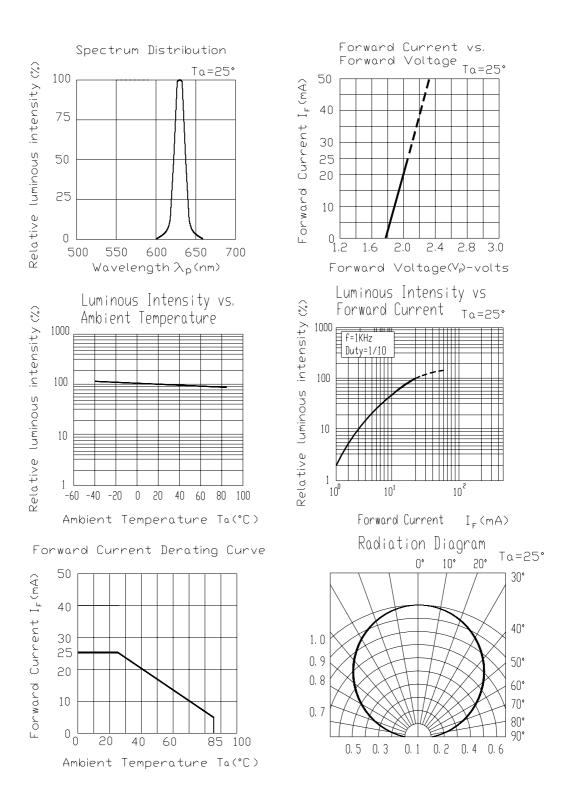
0. 1

0. 2

0. 4

Typical Electro-Optical Characteristics Curves

R6

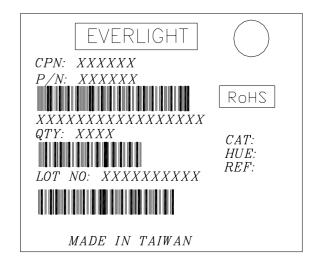


Label explanation

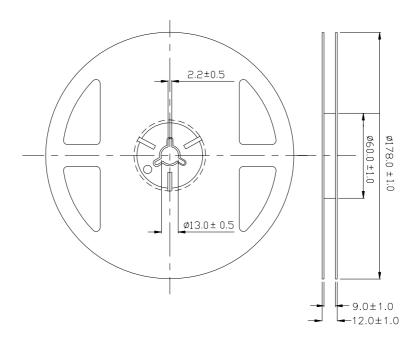
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



Reel Dimensions

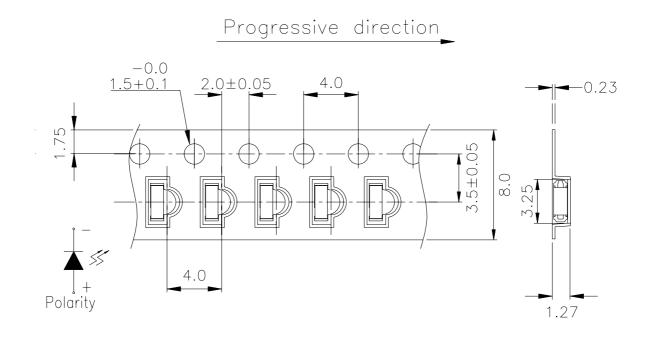


Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Everlight Electronics Co., Ltd. http://www.everlight.com Rev: 3 Page: 7 of 11

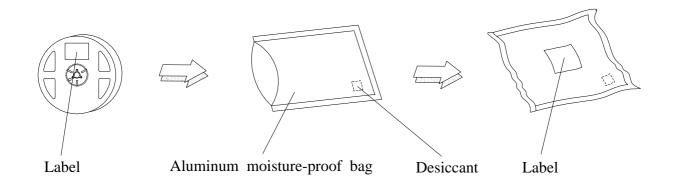
Device No: DSE-122-067 Prepared date: 19-Oct-2005 Prepared by: Jeff Tsai

Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



Everlight Electronics Co., Ltd. http://www.everlight.com Rev: 3 Page: 8 of 11

Device No: DSE-122-067 Prepared date: 19-Oct-2005 Prepared by: Jeff Tsai



Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min $\int 5 \text{ min}$ $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	$H: +100^{\circ}\mathbb{C}$ 5min $\int 10 \sec$ $L: -10^{\circ}\mathbb{C}$ 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°ℂ	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1

Everlight Electronics Co., Ltd. http://www.everlight.com Rev: 3 Page: 9 of 11

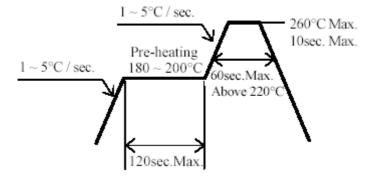
Device No: DSE-122-067 Prepared date: 19-Oct-2005 Prepared by: Jeff Tsai

Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30 deg C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.
 - Baking treatment : $60\pm5^{\circ}$ C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

Everlight Electronics Co., Ltd. http://www.everlight.com Rev: 3 Page: 10 of 11

Device No: DSE-122-067 Prepared date: 19-Oct-2005 Prepared by: Jeff Tsai

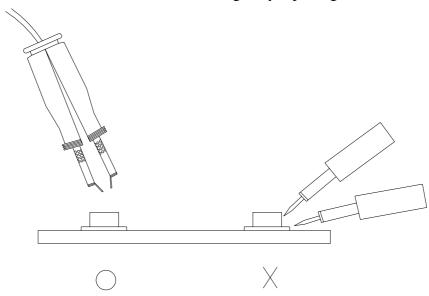


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.

Office: No 25, Lane 76, Sec 3, Chung Yang Rd, Tucheng, Taipei 236, Taiwan, R.O.C Tel: 886-2-2267-2000, 2267-9936

Fax: 886-2267-6244, 2267-6189, 2267-6306

http://www.everlight.com

Everlight Electronics Co., Ltd. http://www.everlight.com Rev: 3 Page: 11 of 11

Device No: DSE-122-067 Prepared date: 19-Oct-2005 Prepared by: Jeff Tsai